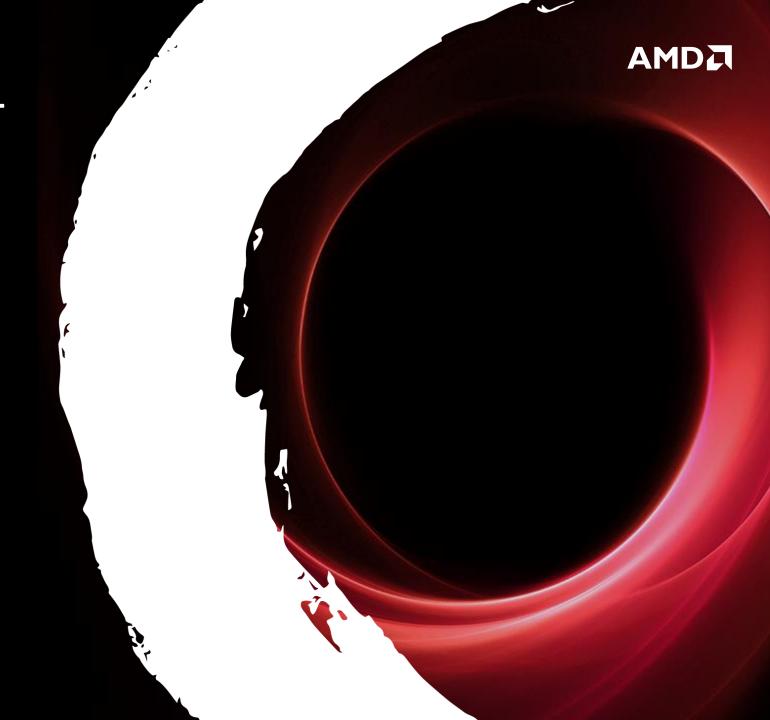
A NEW X86 CORE ARCHITECTURE FOR THE NEXT GENERATION OF COMPUTING

MIKE CLARK
SENIOR FELLOW





THE ROAD TO ZEN

HIGH LEVEL ARCHITECTURE

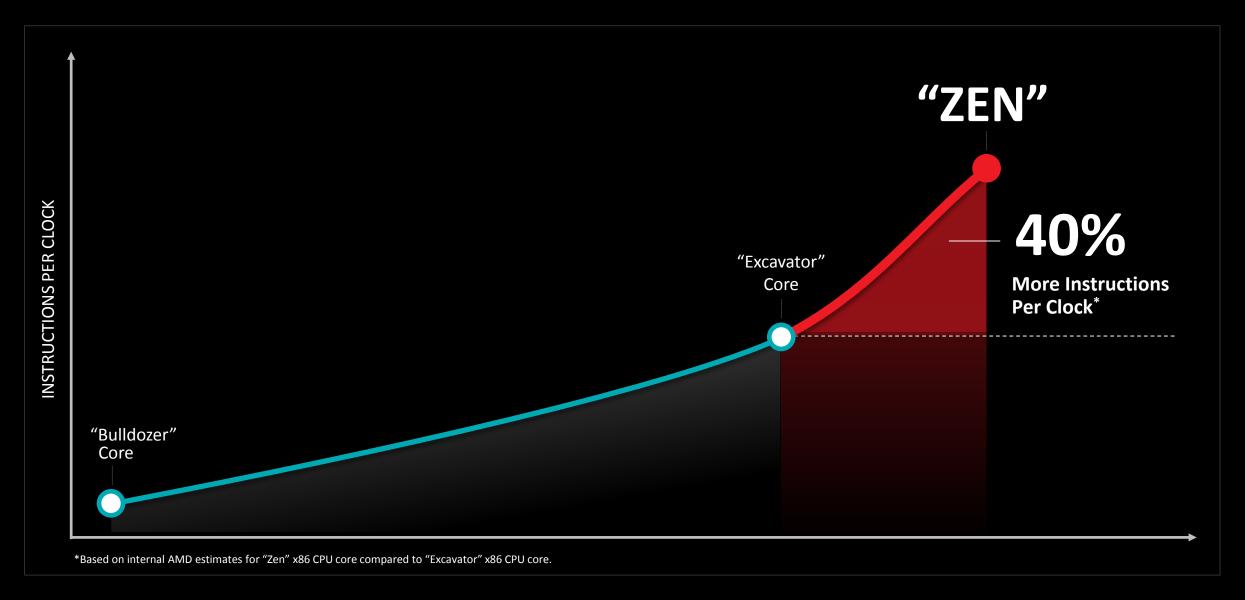
- IMPROVEMENTS IN CORE ENGINE
- FLOATING POINT
- IMPROVEMENTS IN CACHE SYSTEM
- SMT DESIGN TO MAXIMIZE THROUGHPUT
- **NEW ISA EXTENSIONS**

SUMMARY

NEXT STEP UP

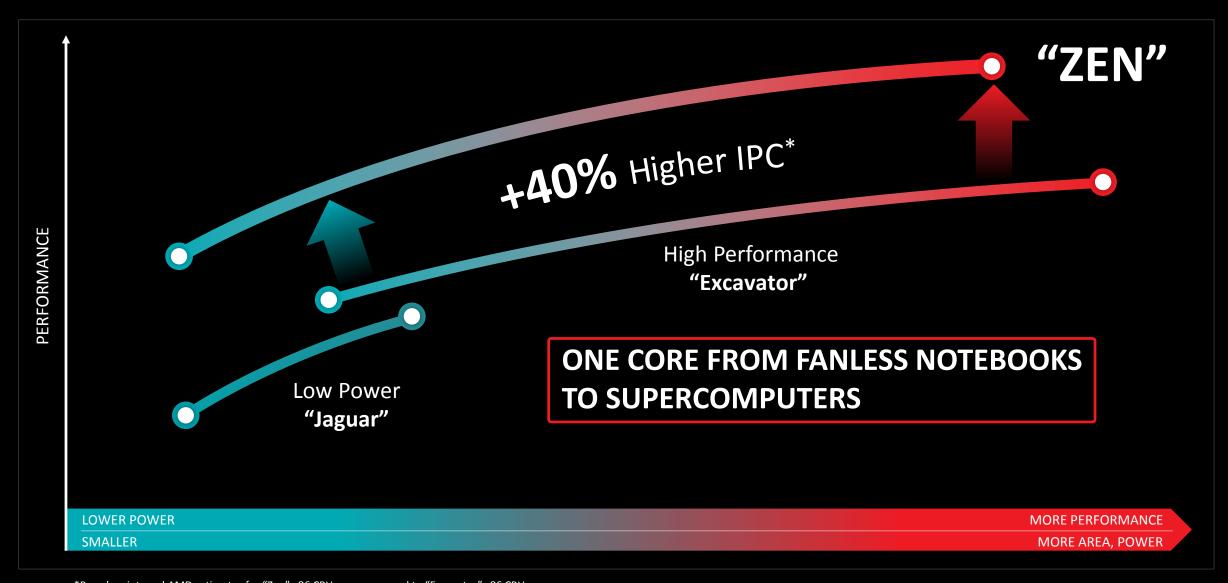
AMD X86 CORES: DRIVING COMPETITIVE PERFORMANCE





AMD CPU DESIGN OPTIMIZATION POINTS

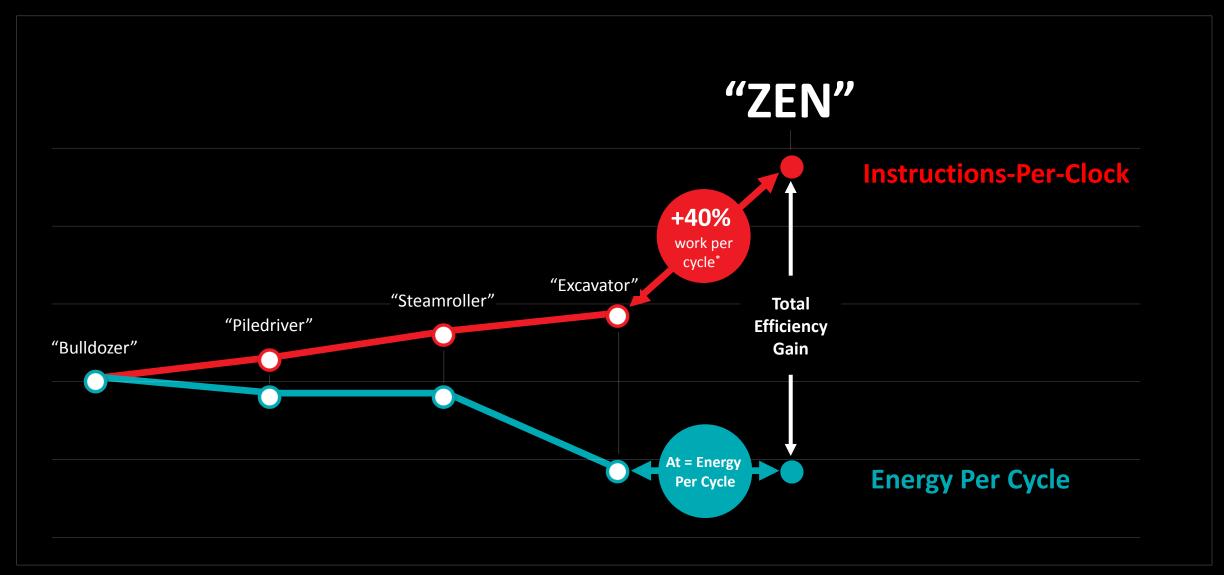




^{*}Based on internal AMD estimates for "Zen" x86 CPU core compared to "Excavator" x86 CPU core.

DEFYING CONVENTION: A WIDE, HIGH PERFORMANCE, EFFICIENT CORE





^{*}Based on internal AMD estimates for "Zen" x86 CPU core compared to "Excavator" x86 CPU core.

ZEN PERFORMANCE & POWER IMPROVEMENTS



BETTER CORE ENGINE

- Two threads per core
- Branch mispredict improved
- Better branch prediction with 2 branches per BTB entry
- Large Op Cache
- Wider micro-op dispatch 6 vs. 4
- Larger Instruction SchedulersInteger: 84 vs. 48 | FP: 96 vs. 60
- Larger retire 8 ops vs. 4 ops
- Quad issue FPU
- Larger Retire Queue 192 vs. 128
- Larger Load Queue 72 vs. 44
- Larger Store Queue 44 vs. 32

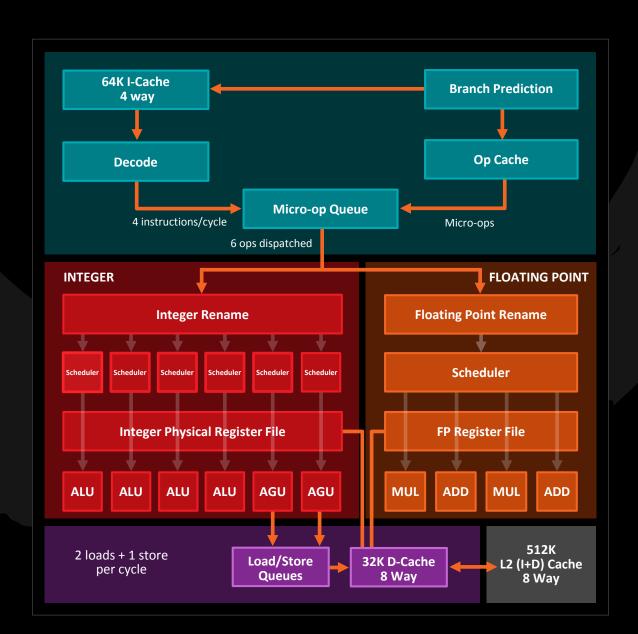
BETTER CACHE SYSTEM

- Write back L1 cache
- Faster L2 cache
- Faster L3 cache
- Faster Load to FPU: 7 vs. 9 cycles
- Better L1 and L2 data prefetcher
- Close to 2x the L1 and L2 bandwidth
- Total L3 bandwidth up 5x

LOWER POWER

- Aggressive clock gating with multi-level regions
- Write back L1 cache
- Large Op Cache
- Stack Engine
- Move elimination
- Power focus from project inception
- Low Power Design Methodologies

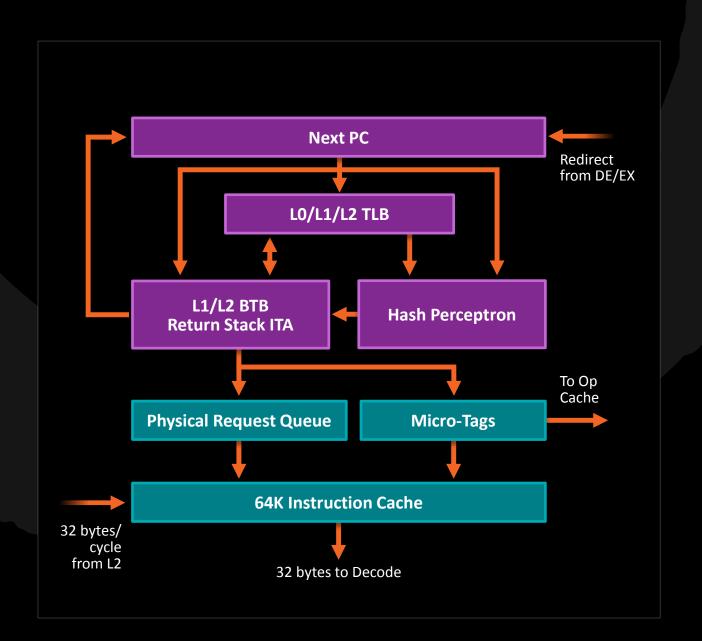
40% IPC PERFORMANCE UPLIFT





ZEN MICROARCHITECTURE

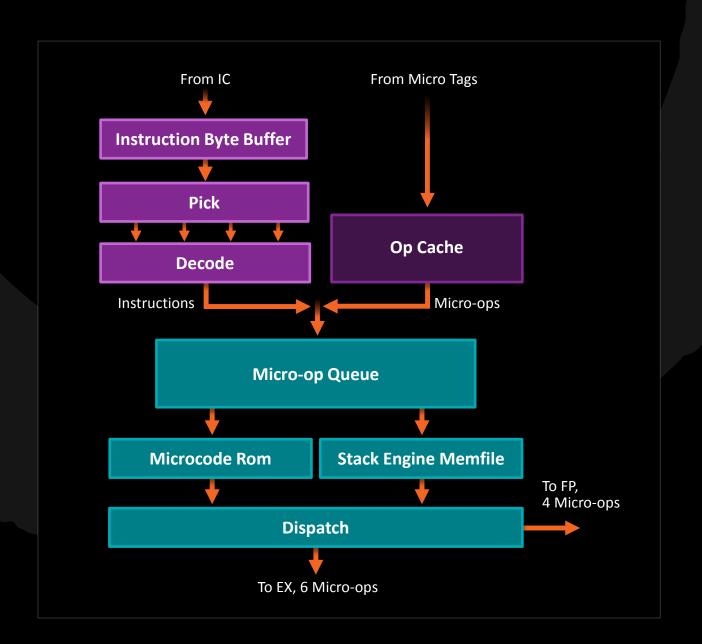
- Fetch Four x86 instructions
- Op Cache instructions
- 4 Integer units
 - Large rename space 168 Registers
 - 192 instructions in flight/8 wide retire
- ✓ 2 Load/Store units
 - 72 Out-of-Order Loads supported
- ✓ 2 Floating Point units x 128 FMACs
 - built as 4 pipes, 2 Fadd, 2 Fmul
- ✓ I-Cache 64K, 4-way
- ✓ D-Cache 32K, 8-way
- ∠ L2 Cache 512K, 8-way
- Large shared L3 cache
- 2 threads per core





FETCH

- **Decoupled Branch Prediction**
- ✓ TLB in the BP pipe
 - 8 entry LO TLB, all page sizes
 - 64 entry L1 TLB, all page sizes
 - 512 entry L2 TLB, no 1G pages
- ∠ 2 branches per BTB entry
- ✓ Large L1 / L2 BTB
- ✓ 32 entry return stack
- Indirect Target Array (ITA)
- 64K, 4-way Instruction cache
- Micro-tags for IC & Op cache
- 32 byte fetch

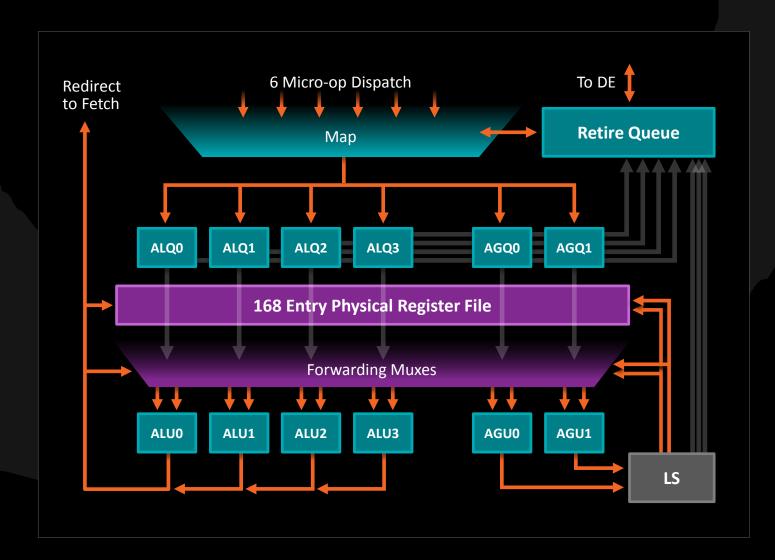




DECODE

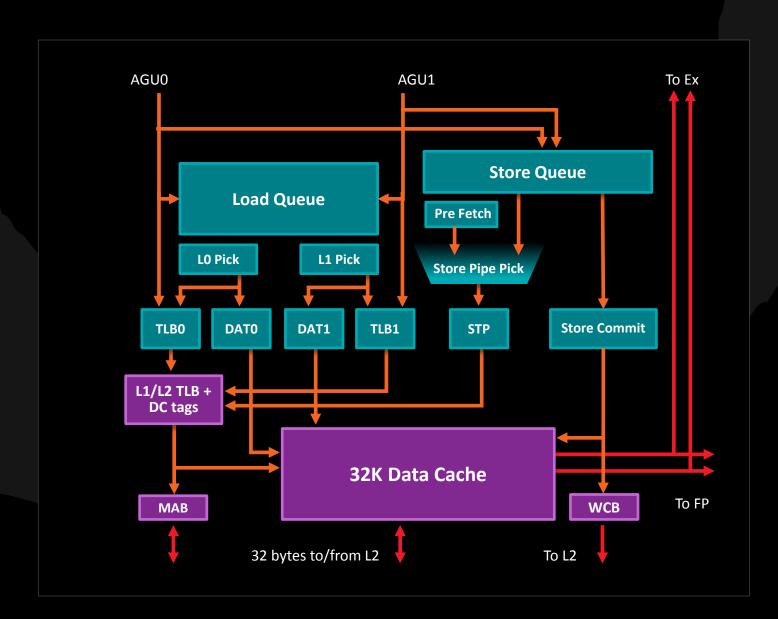
- ✓ Inline Instruction-length Decoder
- Decode 4 x86 instructions
- Op cache
- Micro-op Queue
- Stack Engine
- Branch Fusion
- ✓ Memory File for Store to Load Forwarding





EXECUTE

- ✓ 168 entry Physical Register File
- ✓ 6 issue per cycle
 - 4 ALU's, 2 AGU's
- ✓ 192 entry Retire Queue
- ✓ Differential Checkpoints
- ✓ 2 Branches per cycle
- Move Elimination
- 8-Wide Retire

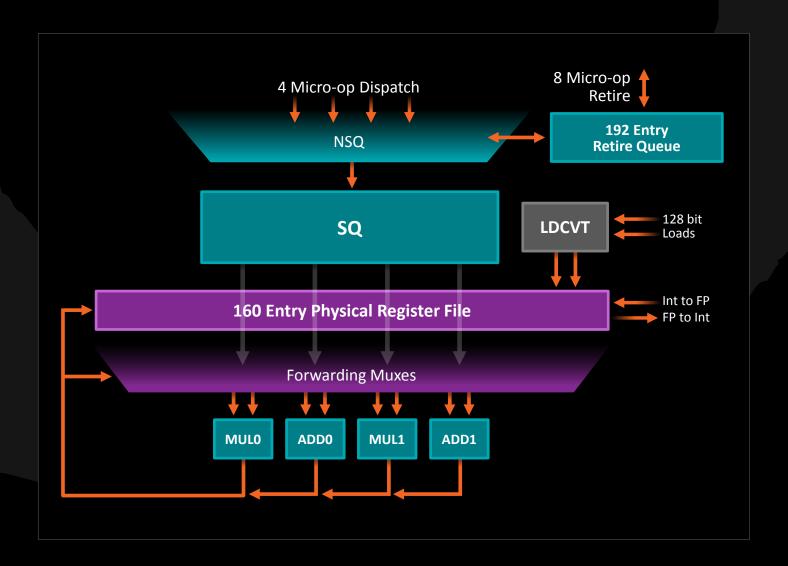




LOAD/STORE AND L2

- 72 Out of Order Loads
- ∠ 44 entry Store Queue
- ✓ Split TLB/Data Pipe, store pipe
- 64 entry L1 TLB, all page sizes
- ✓ 1.5K entry L2 TLB, no 1G pages
- ✓ 32K, 8 way Data Cache
 - Supports two 128-bit accesses
- ✓ Optimized L1 and L2 Prefetchers
- ✓ 512K, private (2 threads), inclusive L2

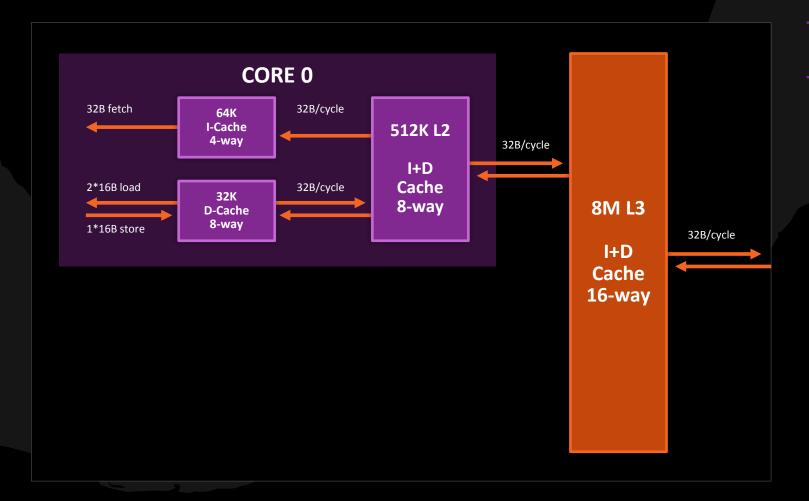




FLOATING POINT

- ∠ 2 Level Scheduling Queue
- ✓ 160 entry Physical Register File
- 8 Wide Retire
- ✓ 1 pipe for 1x128b store
- ✓ SSE, AVX1, AVX2, AES, SHA, and legacy mmx/x87 compliant
- ✓ 2 AES units

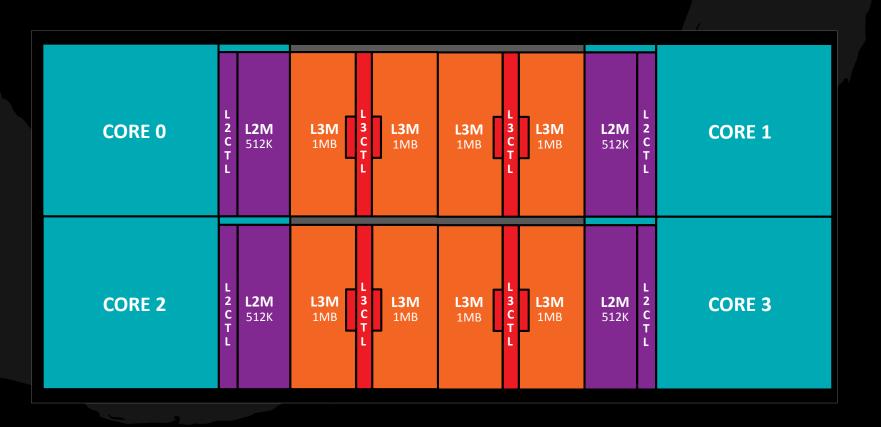




ZEN CACHE HIERARCHY

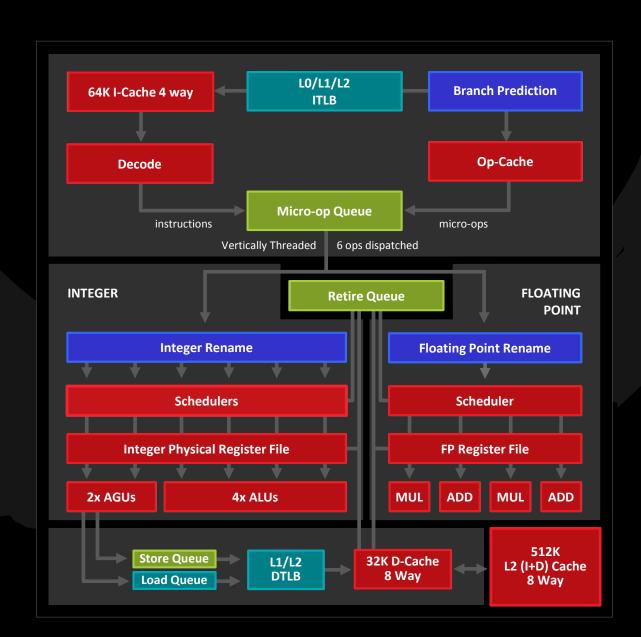
- Fast private 512K L2 cache
- Fast shared L3 cache
- High bandwidth enables prefetch improvements
- ▲ L3 is filled from L2 victims
- ✓ Fast cache-to-cache transfers
- ✓ Large Queues for Handling L1 and L2 misses





CPU COMPLEX

- ▲ A CPU complex (CCX) is four cores connected to an L3 Cache.
- The L3 Cache is 16-way associative, 8MB, mostly exclusive of L2.
- The L3 Cache is made of 4 slices, by low-order address interleave.
- Every core can access every cache with same average latency





SMT OVERVIEW

- All structures fully available in 1T mode
- Front End Queues are round robin with priority overrides
- Increased throughput from SMT

- Competitively shared structures
- Competitively shared and SMT Tagged
- Competitively shared with Algorithmic Priority
- Statically Partitioned

NEW INSTRUCTIONS

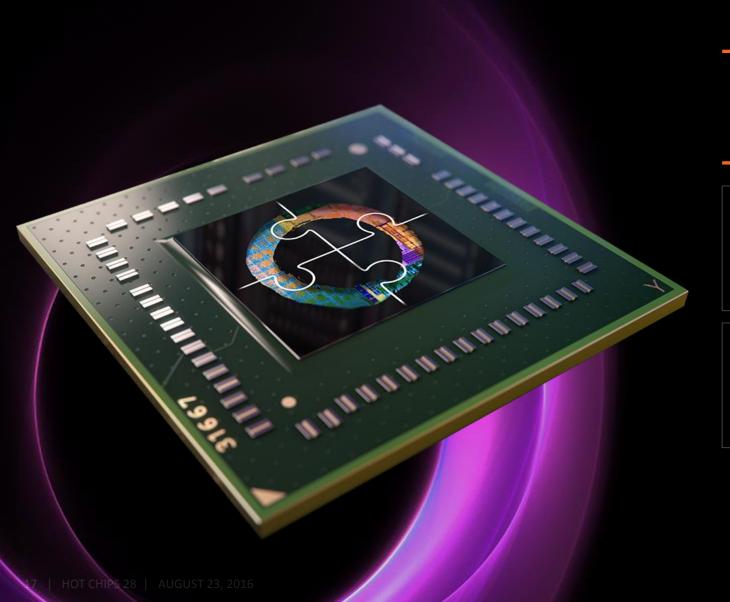


Feature	Notes	Excavator	Zen
ADX	Extending multi-precision arithmetic support		✓
RDSEED	Complement to RDRAND random number generation		✓
SMAP	Supervisor Mode Access Prevention		✓
SHA1/SHA256	Secure Hash Implementation Instructions		✓
CLFLUSHOPT	CLFLUSH ordered by SFENCE		✓
XSAVEC/XSAVES/XRSTORS	New Compact and Supervisor Save/Restore		✓
CLZERO	Clear Cache Line		✓
PTE Coalescing	Combines 4K page tables into 32K page size		√

AMD Exclusive

We support all the standard ISA including AVX &AVX-2, BMI1 & BMI2, AES, RDRAND, SMEP





"ZEN"

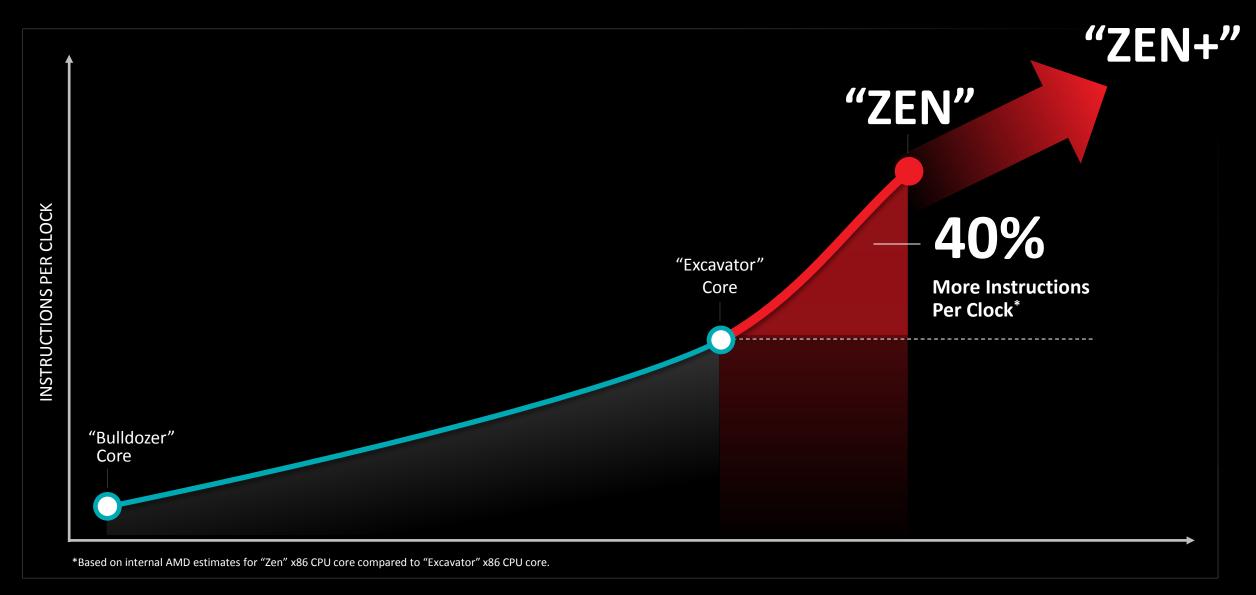
DESIGNED FROM THE GROUND UP FOR OPTIMAL BALANCE OF PERFORMANCE AND POWER

Totally New High-performance Core Design New High-Bandwidth, Low Latency Cache System

Simultaneous
Multithreading (SMT)
for High Throughput

Energy-efficient FinFET
Design Scales from
Enterprise to Client
Products

A COMMITTED ROADMAP TO X86 PERFORMANCE





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